

**APPLICATION DATA SHEET**

**APPLICATION INFORMATION**

Application Number::	Not Yet Assigned
Filing Date::	Filed Concurrently Herewith
Application Type::	Regular
Subject Matter::	Utility
CD-ROM or CD-R?::	None
Computer Readable Form (CRF)?::	No
Title::	SURFACE-PROTECTING SHEET AND SEMICONDUCTOR WAFER LAPPING METHOD
Attorney Docket Number::	1217-060907
Request for Early Publication?::	No
Request for Non-Publication?::	No
Total Drawing Sheets::	2
Small Entity?::	No
Secrecy Order In Parent Appl.?::	No

**APPLICANT INFORMATION**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	JAPAN
Status::	Full Capacity
Given Name::	Koichi
Family Name::	NAGAMOTO
City of Residence::	Saitama-shi
State or Province of Residence::	Saitama
Country of Residence::	JAPAN
Street of Mailing Address::	7-7-3-301, Tsuji, Minami-ku
City of Mailing Address::	Saitama-shi
State or Province of Mailing Address::	Saitama
Country of Mailing Address::	JAPAN
Postal or Zip Code of Mailing Address::	3360026
Applicant Authority Type::	Inventor
Primary Citizenship Country::	JAPAN
Status::	Full Capacity

Given Name:: Hitoshi  
 Family Name:: OHASHI  
 City of Residence:: Saitama-shi  
 State or Province of Residence:: Saitama  
 Country of Residence:: JAPAN  
 Street of Mailing Address:: 2-20-18-216, Harigaya, Urawa-ku  
 City of Mailing Address:: Saitama-shi  
 State or Province of Mailing Address:: Saitama  
 Country of Mailing Address:: JAPAN  
 Postal or Zip Code of Mailing Address:: 3300075

Applicant Authority Type:: Inventor  
 Primary Citizenship Country:: JAPAN  
 Status:: Full Capacity  
 Given Name:: Kazuhiro  
 Family Name:: TAKAHASHI  
 City of Residence:: Kawaguchi-shi  
 State or Province of Residence:: Saitama  
 Country of Residence:: JAPAN  
 Street of Mailing Address:: 5-3-17, Shiba  
 City of Mailing Address:: Kawaguchi-shi  
 State or Province of Mailing Address:: Saitama  
 Country of Mailing Address:: JAPAN  
 Postal or Zip Code of Mailing Address:: 3330866

#### REPRESENTATIVE INFORMATION

Representative Customer Number::	28289	
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#### FOREIGN PRIORITY INFORMATION

Country::	Application number::	Filing Date::	Priority Claimed::
WIPO	PCT/JP2004/015131	October 14, 2004	Yes
JP	2003-356280	October 16, 2003	Yes

#### ASSIGNMENT INFORMATION

Assignee Name:: Lintec Corporation

Street of Mailing Address::	23-23, Honcho
City of Mailing Address::	Itabashi-ku
State or Province of Mailing Address::	Tokyo
Country of Mailing Address::	JAPAN
Postal or Zip Code of Mailing Address::	1730001